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FDMC5614P

P-Channel PowerTrench[®] MOSFET

-60V, -13.5A, 100mΩ

Features

- Max $r_{DS(on)}$ = 100mΩ at $V_{GS} = -10V$, $I_D = -5.7A$
- Max $r_{DS(on)}$ = 135mΩ at $V_{GS} = -4.5V$, $I_D = -4.4A$
- Low gate charge
- Fast switching speed
- High performance trench technology for extremely low $r_{DS(on)}$
- High power and current handling capability
- RoHS Compliant

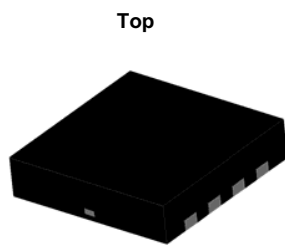


General Description

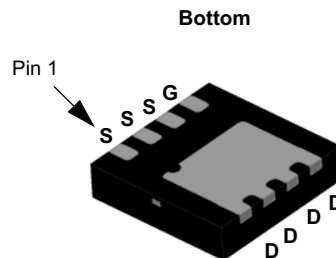
This P-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench[®] process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (4.5V-20V).

Application

- Power management
- Load switch
- Battery protection



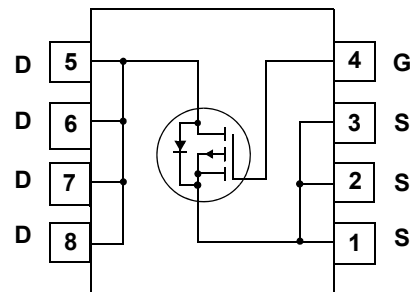
Top



Bottom

Pin 1

MLP 3.3x3.3



MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	-60	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current -Continuous (Package limited) $T_C = 25^\circ\text{C}$	-13.5	A
	-Continuous (Silicon limited) $T_C = 25^\circ\text{C}$	-14	
	-Continuous $T_A = 25^\circ\text{C}$ (Note 1a)	-5.7	
	-Pulsed	-23	
P_D	Power Dissipation $T_C = 25^\circ\text{C}$	42	W
	Power Dissipation $T_A = 25^\circ\text{C}$ (Note 1a)	2.1	
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.0	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	60	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
5614P	FDMC5614P	Power 33	7"	8mm	3000 units

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = -250\mu\text{A}$, $V_{GS} = 0\text{V}$	-60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$, referenced to 25°C		-54		mV/ $^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48\text{V}$, $V_{GS} = 0\text{V}$			-1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$			± 100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = -250\mu\text{A}$	-1	-1.95	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$, referenced to 25°C		4.7		mV/ $^\circ\text{C}$
$r_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = -10\text{V}$, $I_D = -5.7\text{A}$		84	100	m Ω
		$V_{GS} = -4.5\text{V}$, $I_D = -4.4\text{A}$		108	135	
		$V_{GS} = -10\text{V}$, $I_D = -5.7\text{A}$, $T_J = 125^\circ\text{C}$		140	168	
g_{FS}	Forward Transconductance	$V_{DS} = -15\text{V}$, $I_D = -5.7\text{A}$		11		S

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = -30\text{V}$, $V_{GS} = 0\text{V}$, $f = 1\text{MHz}$		795	1055	pF
C_{oss}	Output Capacitance			140	185	pF
C_{rss}	Reverse Transfer Capacitance			60	90	pF

Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -30\text{V}$, $I_D = -1\text{A}$ $V_{GS} = -10\text{V}$, $R_{GEN} = 6\Omega$		10	21	ns
t_r	Rise Time			11	23	ns
$t_{d(off)}$	Turn-Off Delay Time			32	65	ns
t_f	Fall Time			11	22	ns
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = -10\text{V}$		15	20	nC
Q_{gs}	Gate to Source Gate Charge	$V_{DD} = -30\text{V}$		1.6	2.1	nC
Q_{gd}	Gate to Drain "Miller" Charge	$I_D = -5.7\text{A}$		2.7	3.5	nC

Drain-Source Diode Characteristics

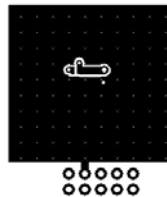
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{V}$, $I_S = -3.2\text{A}$		-0.8	-1.2	V
t_{rr}	Reverse Recovery Time	$I_F = -3.2\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$			36	ns
Q_{rr}	Reverse Recovery Charge				29	nC

Notes:

1: $R_{\theta JA}$ is determined with the device mounted on a 1 in² oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta JA}$ is determined by the user's board design.

(a) $R_{\theta JA} = 60^\circ\text{C}/\text{W}$ when mounted on a 1 in² pad of 2 oz copper, 1.5"x1.5"x0.062" thick PCB.

(b) $R_{\theta JA} = 135^\circ\text{C}/\text{W}$ when mounted on a minimum pad of 2 oz copper.



a. $60^\circ\text{C}/\text{W}$ when mounted on a 1 in² pad of 2 oz copper



b. $135^\circ\text{C}/\text{W}$ when mounted on a minimum pad of 2 oz copper

2: Pulse Test: Pulse Width < 300 μs , Duty cycle < 2.0%.

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

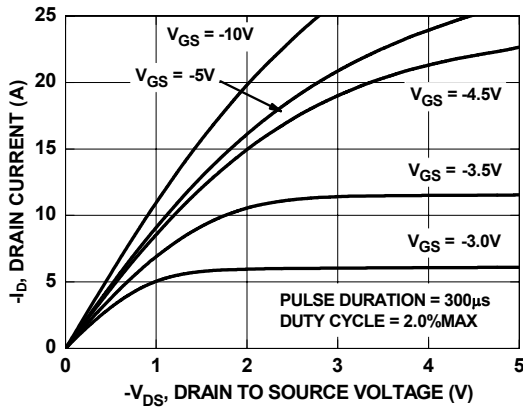


Figure 1. On-Region Characteristics

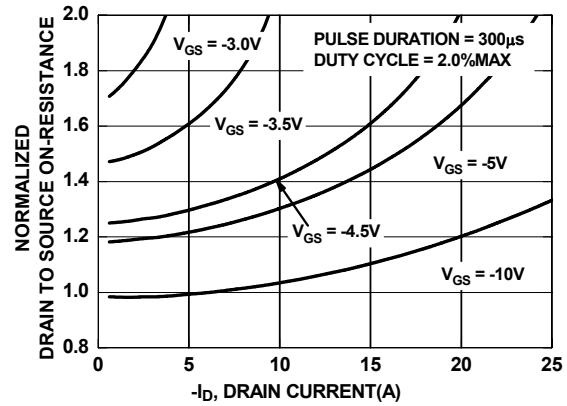


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

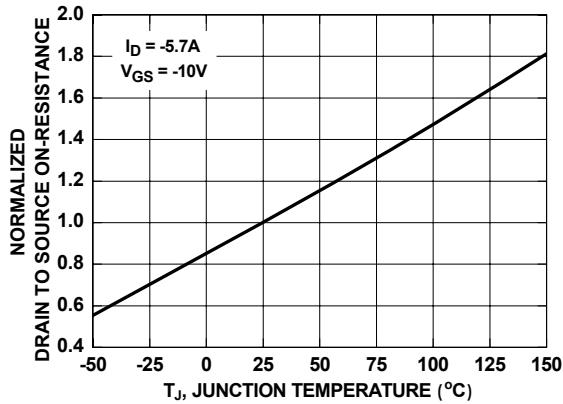


Figure 3. Normalized On-Resistance vs Junction Temperature

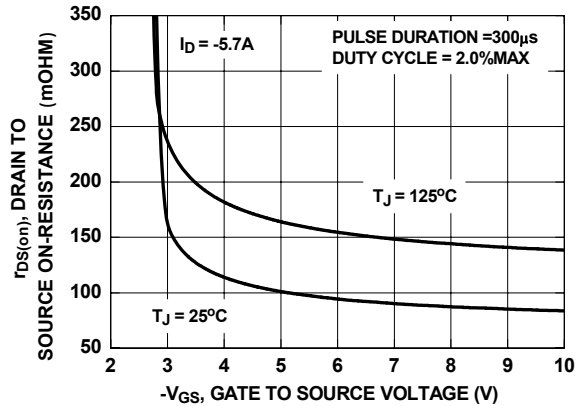


Figure 4. On-Resistance vs Gate to Source Voltage

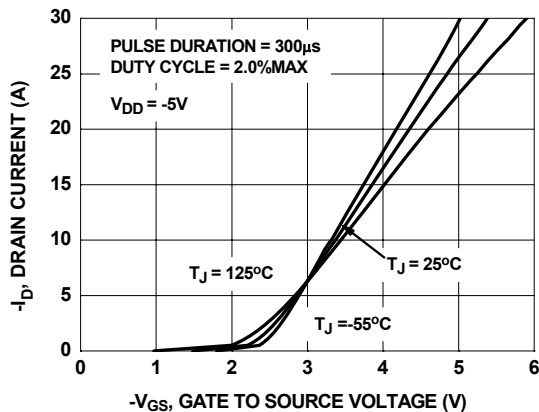


Figure 5. Transfer Characteristics

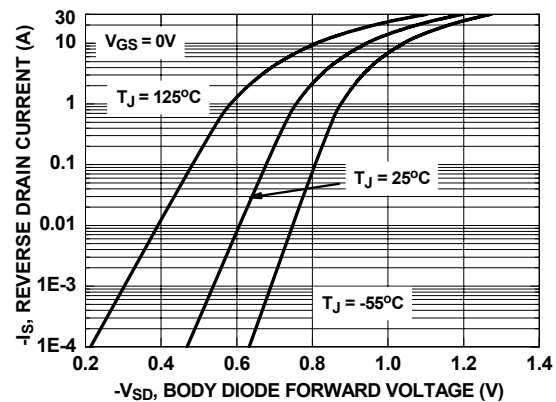


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

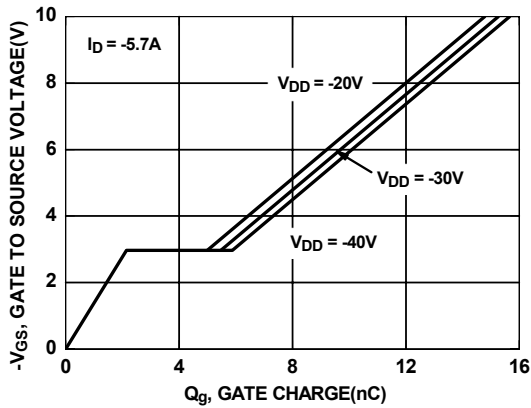


Figure 7. Gate Charge Characteristics

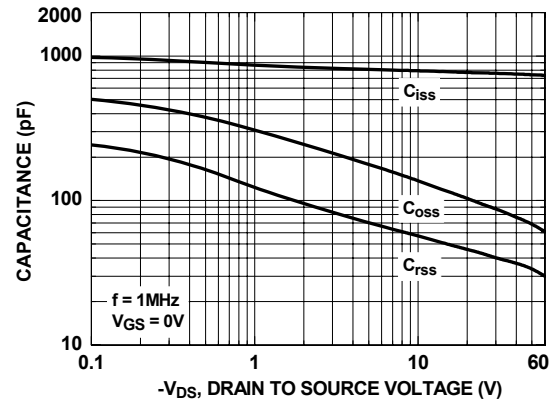


Figure 8. Capacitance vs Drain to Source Voltage

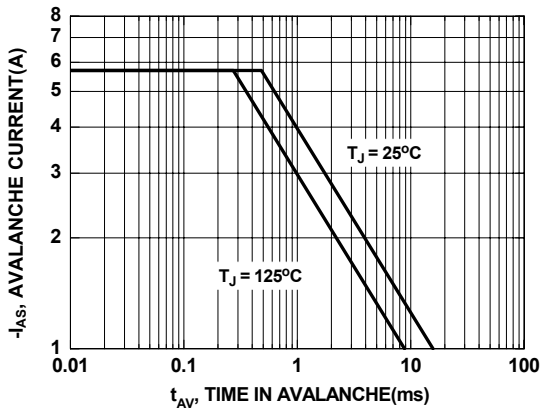


Figure 9. Unclamped Inductive Switching Capability

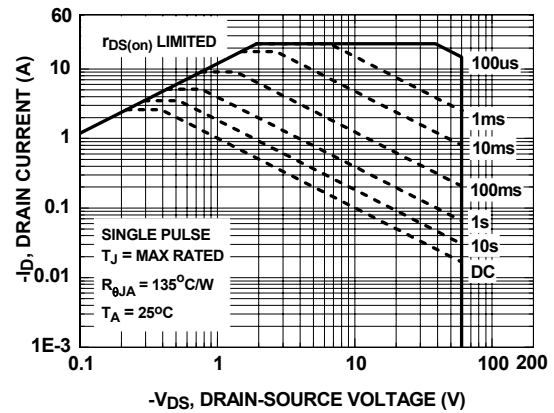


Figure 10. Forward Bias Safe Operating Area

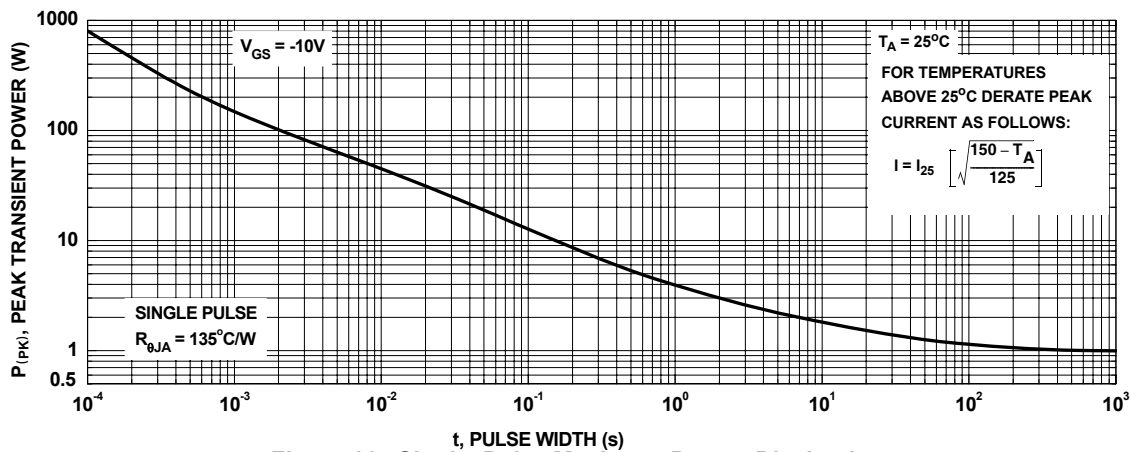
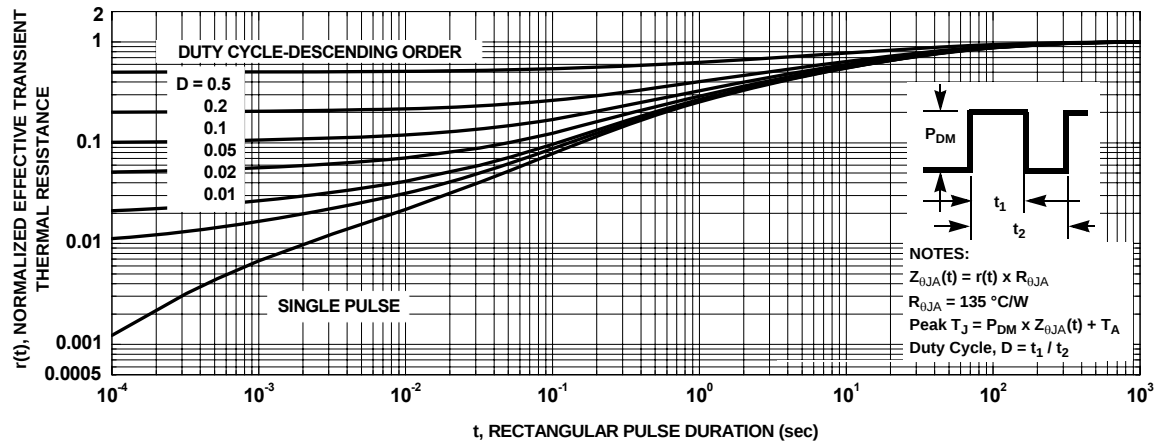
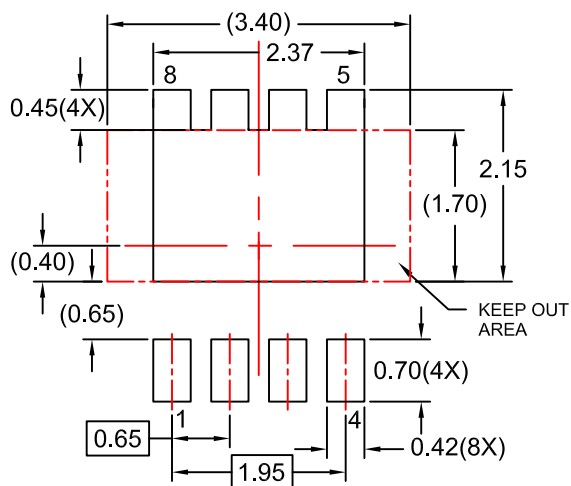
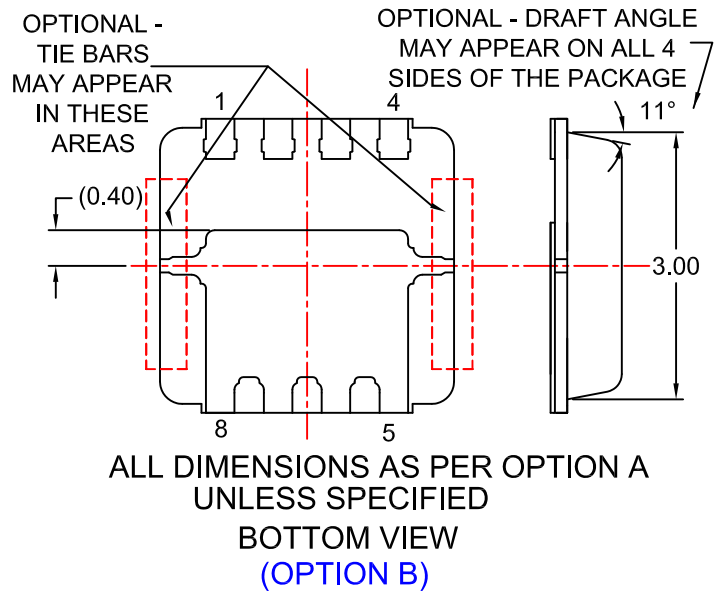
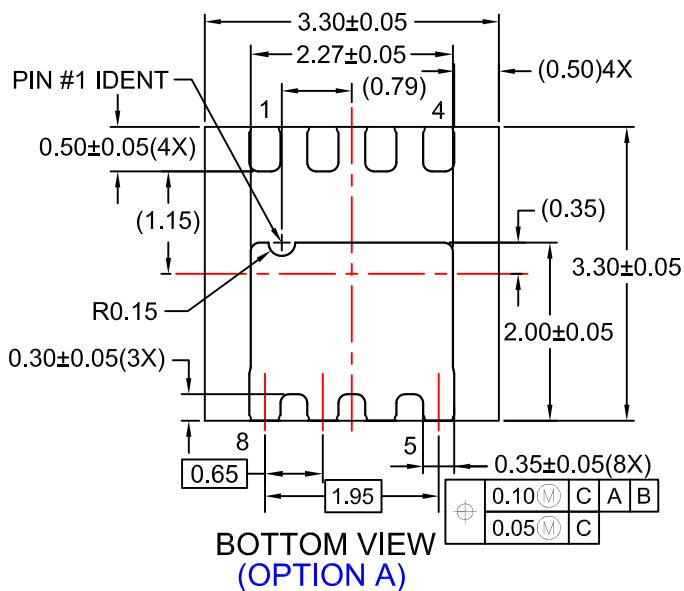
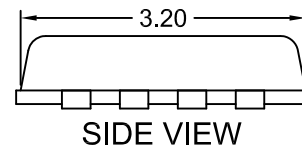
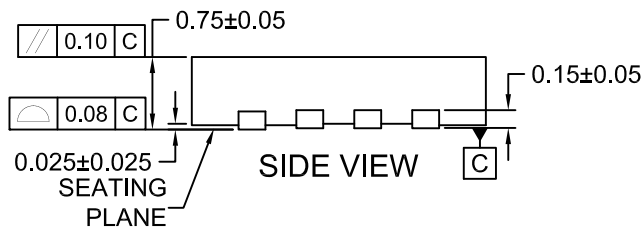
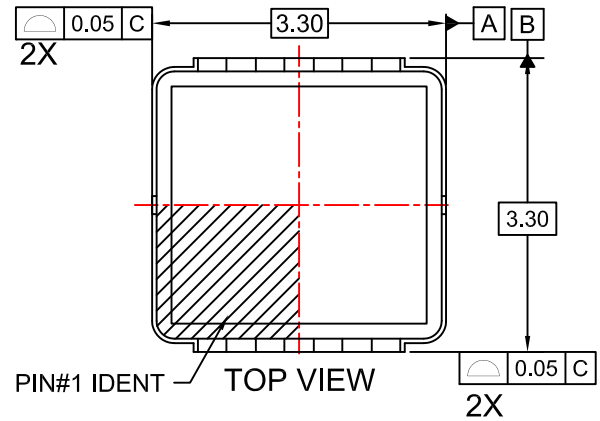
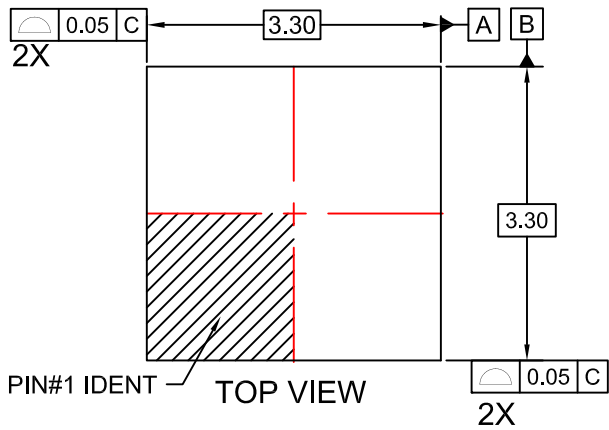


Figure 11. Single Pulse Maximum Power Dissipation

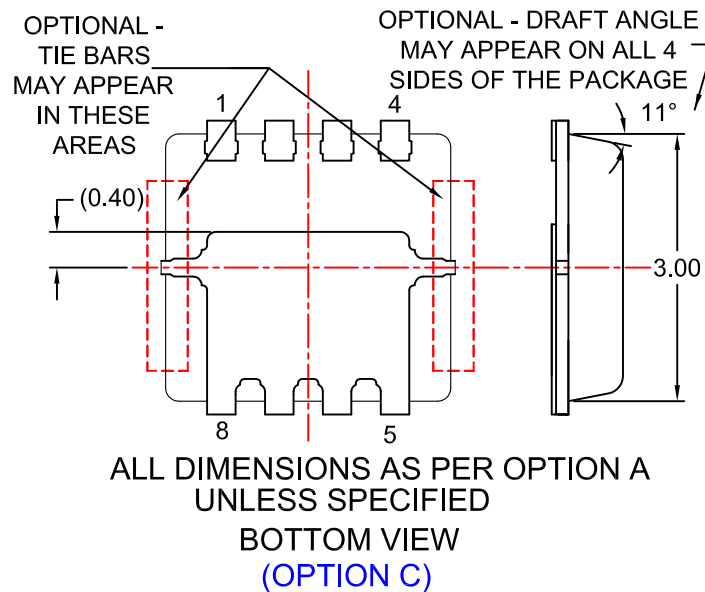
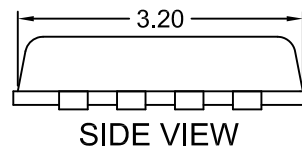
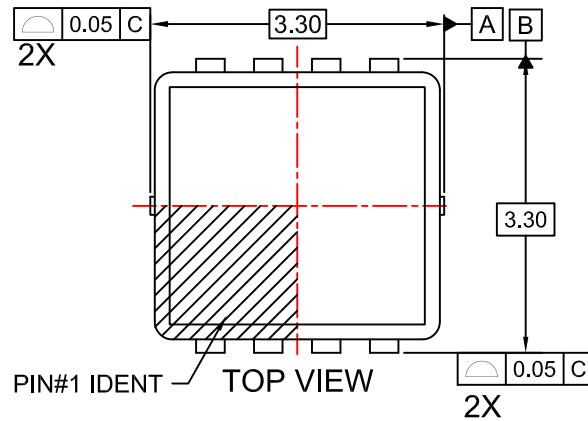
Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted





RECOMMENDED LAND PATTERN





NOTES:

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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN
- E. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. BURRS OR MOLD FLASH SHALL NOT EXCEED 0.10MM.
- F. DRAWING FILENAME: MKT-MLP08Wrev3.
- G. OPTION A - SAWN MLP, OPTIONS B & C - PUNCH MLP.



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